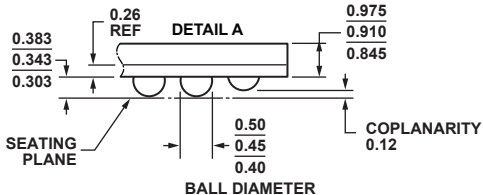
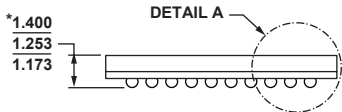
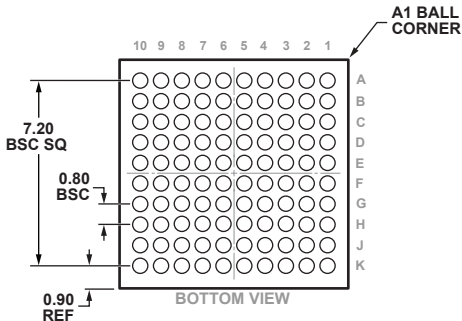
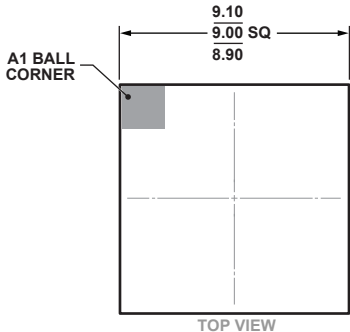


**100-Ball Chip Scale Package Ball Grid Array [CSP\_BGA]**

**(BC-100-4)**

**Dimensions shown in millimeters**



**\*COMPLIANT TO JEDEC STANDARDS MO-275-DDAB-1  
WITH THE EXCEPTION TO PACKAGE HEIGHT**